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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Jack O. Chu Confirmation No.: 5389
Serial No.: 09/769,170 Group No.: 2815
Filed: January 25, 2001 Examiner: E.J. Wojciechowicz

For: A TRANSFERABLE DEVICE-CONTAINING LAYER
FOR SILICON-ON-INSULATOR APPLICATIONS

Commissioner for Patents
Washington, D.C. 20231

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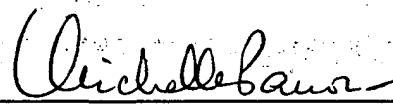
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1.142

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